Surface Mount Zener Diode





Features:

- Planar Die Construction
- 500mW Power Dissipation On Ceramic PCB
- · General Purpose, Medium Current
- · Ideally Suited For Automated Assembly Processes



Cathode

-O 2 Anode



Applications:

- · Zener diode
- Ultra-small surface mount package

Maximum Rating @ T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit | |
|---|------------------|-------------|------|--|
| Forward voltage @ I _F =10mA | V _F | 0.9 | V | |
| Power dissipation | P _D | 500 | mW | |
| Thermal resistance, junction to ambient air | R _{θjA} | 305 | °C/W | |
| Junction temperature | Τ _j | 150 | °C | |
| Storage temperature range | T _{stg} | -65 to +150 | °C | |

Note : Device mounted on ceramic PCB; 7.6mm × 9.4mm × 0.87mm with pad areas 25mm²

Short duration test pulse used to minimize self-heating effect.

When provided, otherwise, parts are provided with date code only, and type number identifications appears on reel only. f = 1 kHz

Electrical Characteristics @ TA = 25°C unless otherwise specified

| _ | | Zener Voltage Range | | | Maximum Zener Impedance | | Maximum Reverse Current | | Typical Temperature Coefficient@ | | Test Current | | |
|----------------|-----------------|---------------------|---------------------------------|--------|----------------------------|----------------------------------|----------------------------------|-----------------|--|-----------------|--------------------|-------|------------------|
| Type Number | Marking Code | | V _z @I _{zt} | | I _{zt} | Z _{zt} @I _{zt} | Z _{zĸ} @l _{zĸ} | l _{zk} | I _R | @V _R | l _{ztc} n | nV/°C | I _{ztc} |
| | | Nom(V) | Min(V) | Max(V) | mA | C | 2 | mA | μA | v | Min | Max | mA |
| BZT52C33 | WR | 33 | 31 | 35 | 2 | 80 | 325 | 0.5 | 0.1 | 23.1 | 27.4 | 33.4 | 2 |





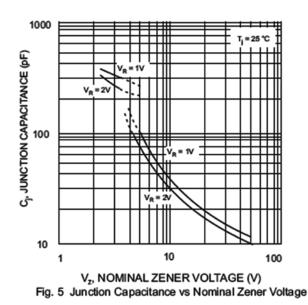
0.6 50 Tj = 25°C C6V8 0.5 40 ||| C8V2 I₂, ZENER CURRENT (mA) P_D, POWER DISSIPATION (W) 0.4 30 0.3 20 0.2 Test Current I_Z 10 5.0mA 0.1 0 0 0 25 50 150 75 100 125 2 5 6 8 9 10 0 3 4 7 1 T_A, AMBIENT TEMPERATURE (°C) Fig. 1 Power Dissipation vs Ambient Temperature Vz, ZENER VOLTAGE (V) Fig. 2 Zener Breakdown Characteristics 30 10 T_i = 25°C cio C39 Tj = 25°C C12 8 I2, ZENER CURRENT (mA) I2, ZENER CURRENT (mA) нн 20 C15 6 C18 Test current I_Z 2mA 4 C22 10 Test Current Iz C27 Test current lz 2mA 5mA C33 C36 2 Í. 0 0 0 10 20 30 40 10 20 30 40 50 60 70 80 90 100 V_z, ZENER VOLTAGE (V) Vz, ZENER VOLTAGE (V) Fig. 3 Zener Breakdown Characteristics Fig. 4 Zener Breakdown Characteristics

Typical Characteristics @ TA = 25°C unless otherwise specified



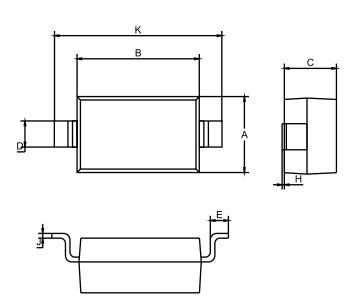
Surface Mount Zener Diode

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Package Outline

Plastic surface mounted package

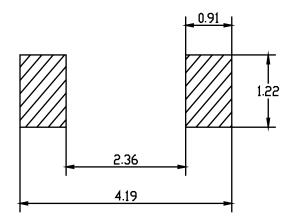


| SOD-123 | | | | |
|----------------------|--------------|------|--|--|
| Dim | Min | Max | | |
| А | 1.4 | 1.8 | | |
| В | 2.55 | 2.85 | | |
| С | 1.15 Typical | | | |
| D | 0.5 | 0.6 | | |
| E | 0.3 | 0.4 | | |
| н | 0.02 | 0.10 | | |
| J | 0.1 Typical | | | |
| К | 3.55 | 3.85 | | |
| All Dimensions in mm | | | | |



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Soldering Footprint



Package Information

| Device | Package | Shipping |
|--------------|---------|-------------------|
| BZT52C33-7-F | SOD-123 | 3,000/Tape & Reel |

Dimensions : Millimetres

Part Number Table

| Description | Part Number | | | |
|---------------------------|--------------|--|--|--|
| Surface Mount Zener Diode | BZT52C33-7-F | | | |

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